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# United States Patent [19]

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Sarnoff et al.

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[54] MICROWAVEABLE CHIP AND DIP SERVER

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[73] Assignee: **Ensar Corporation**, Wheeling, Ill.

[\*\*] Term: **14 Years**

[21] Appl. No.: **5,598**

[22] Filed: **Mar. 8, 1993**

[52] U.S. Cl. .... **D7/557; D7/547; D7/553; D9/429**

[58] Field of Search ..... **D7/539, 504, 367, 604, D7/609, 613, 627, 506, 514, 538, 540, 542, 543, 544, 541, 359, 553, 403, 505, 550, 547, 551, 549, 552, 553, 554, 555, 557, 566, 590, 596, 597, 600, 403, 357, 608, 387; D9/429, 425; 229/2.5 R; 220/632, 575, 670, 574; 108/25**

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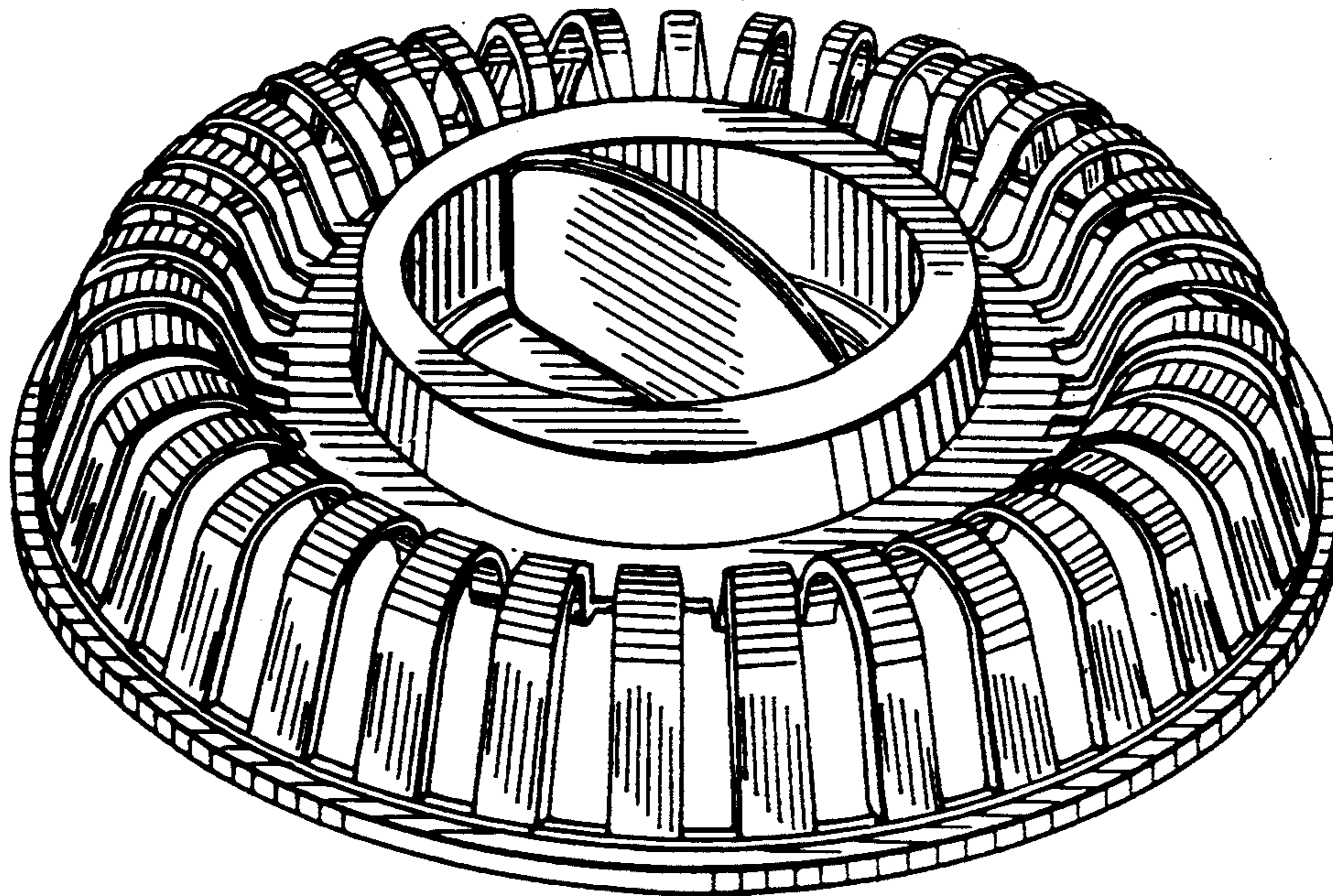
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[57] **CLAIM**

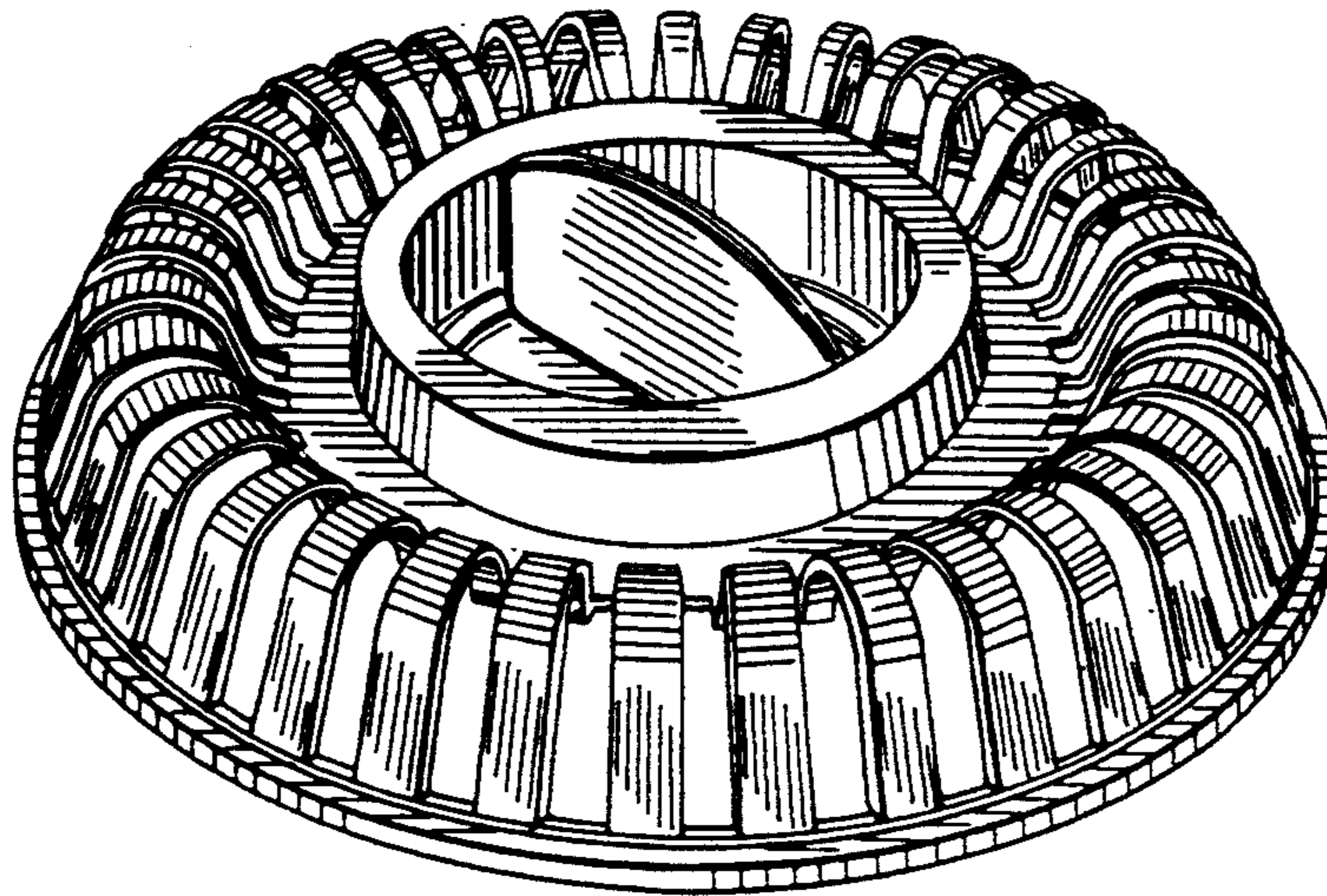
The ornamental design for a microwaveable chip and dip server, as shown and described.

**DESCRIPTION**

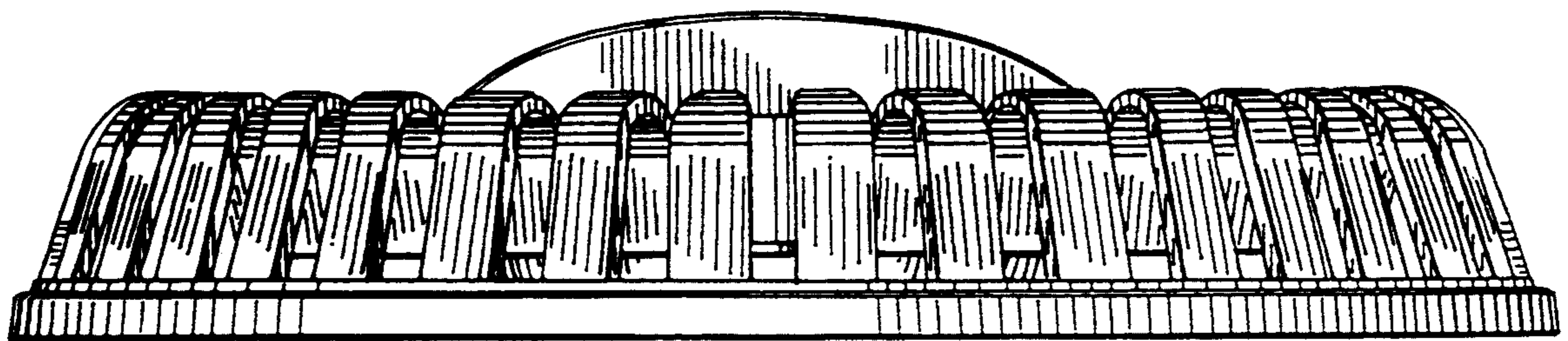
FIG. 1 is a perspective view of a microwaveable chip and dip server of the present invention;  
FIG. 2 is a side elevational view of the microwaveable chip and dip server of FIG. 1, with the opposite side elevational view being identical;  
FIG. 3 is a plan view of the microwaveable chip and dip server of FIG. 1;  
FIG. 4 is a side elevational view of the microwaveable chip and dip server of FIG. 1 taken ninety degrees away from the view of FIG. 2, with the opposite side elevational view being identical; and,  
FIG. 5 is a bottom view of the microwaveable chip and dip server of FIG. 1.



*Fig. 1*

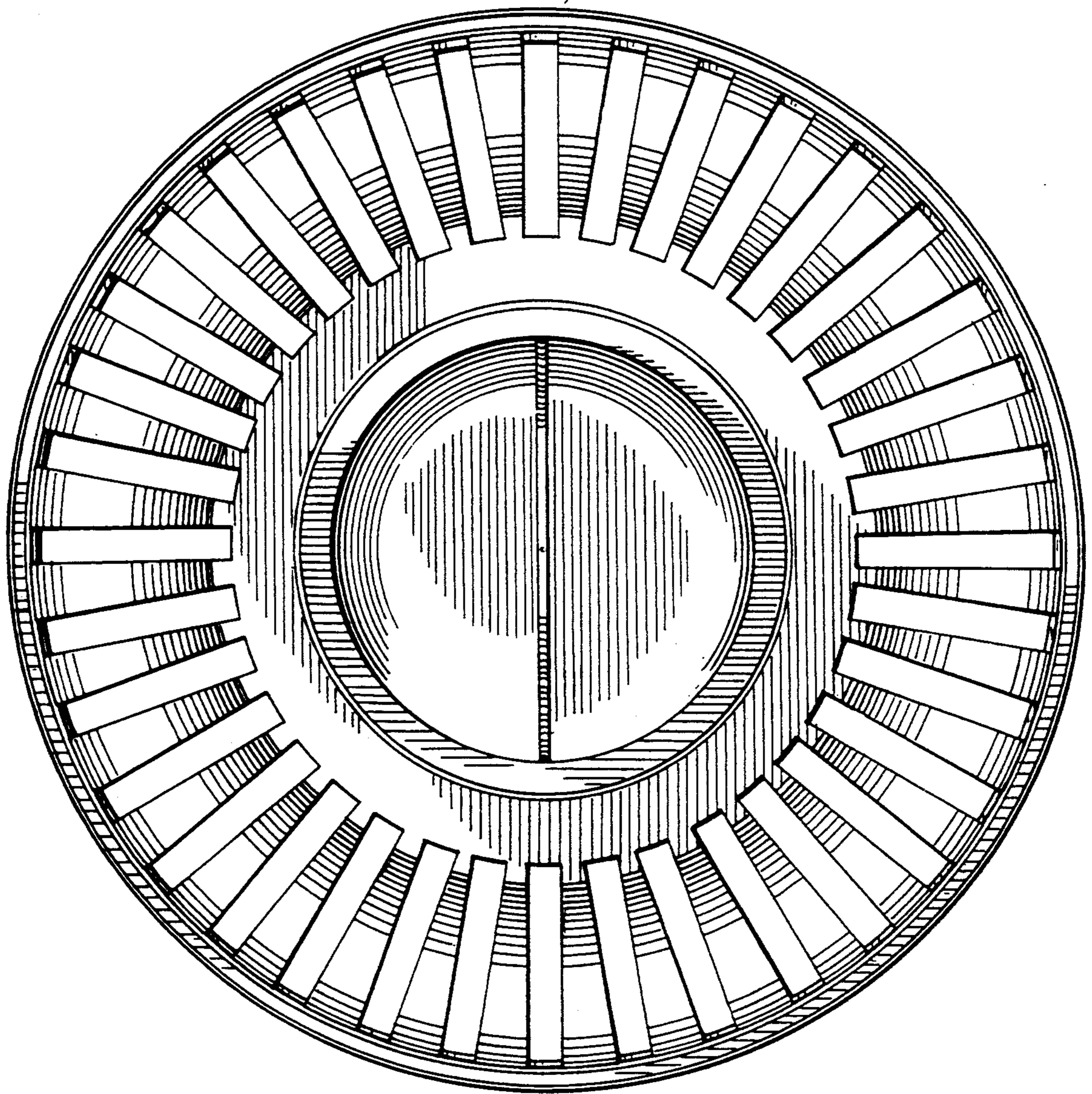


*Fig. 2*

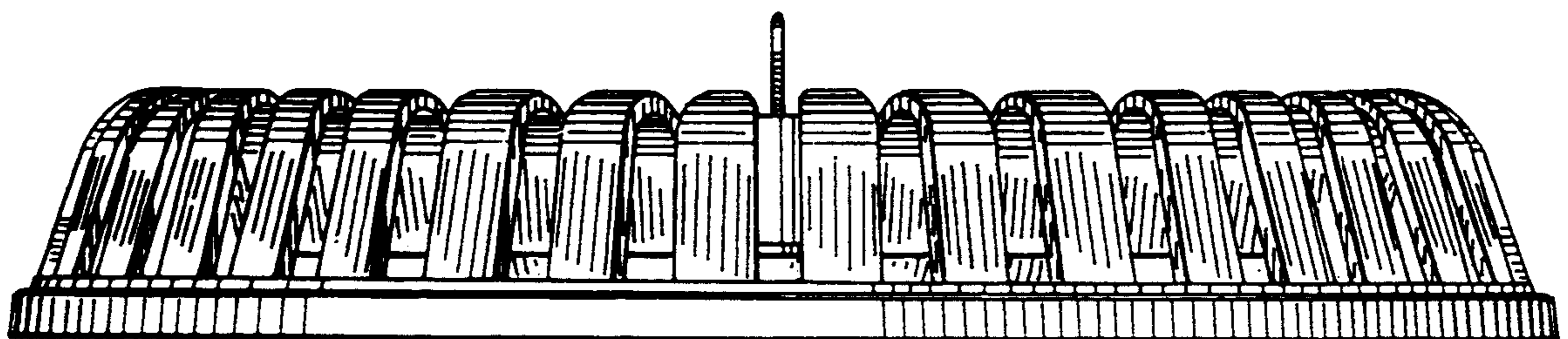




*Fig. 3*



*Fig. 4*





*Fig. 5*

